

MC14008B

4-Bit Full Adder

The MC14008B 4-bit full adder is constructed with MOS P-Channel and N-Channel enhancement mode devices in a single monolithic structure. This device consists of four full adders with fast internal look-ahead carry output. It is useful in binary addition and other arithmetic applications. The fast parallel carry output bit allows high-speed operation when used with other adders in a system.

Features

- Look-Ahead Carry Output
- Diode Protection on All Inputs
- All Outputs Buffered
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- Pin-for-Pin Replacement for CD4008B
- Pb-Free Packages are Available*

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

| Symbol | Parameter | Value | Unit |
|----------------------|---|------------------------|--------------------|
| V_{DD} | DC Supply Voltage Range | -0.5 to +18.0 | V |
| V_{in} , V_{out} | Input or Output Voltage Range (DC or Transient) | -0.5 to $V_{DD} + 0.5$ | V |
| I_{in} , I_{out} | Input or Output Current (DC or Transient) per Pin | ± 10 | mA |
| P_D | Power Dissipation, per Package (Note 1) | 500 | mW |
| T_A | Ambient Temperature Range | -55 to +125 | $^{\circ}\text{C}$ |
| T_{stg} | Storage Temperature Range | -65 to +150 | $^{\circ}\text{C}$ |
| T_L | Lead Temperature (8-Second Soldering) | 260 | $^{\circ}\text{C}$ |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Temperature Derating:

Plastic "P and D/DW" Packages: - 7.0 mW/ $^{\circ}\text{C}$ From 65 $^{\circ}\text{C}$ To 125 $^{\circ}\text{C}$

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

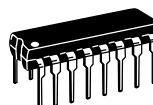
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



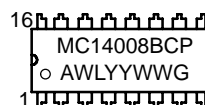
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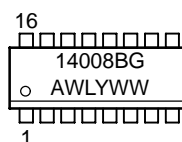
MARKING DIAGRAMS



PDIP-16
P SUFFIX
CASE 648



SOIC-16
D SUFFIX
CASE 751B



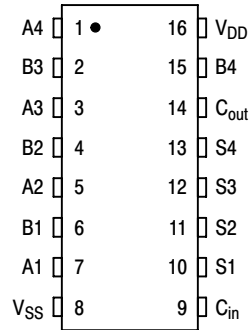
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G = Pb-Free Indicator

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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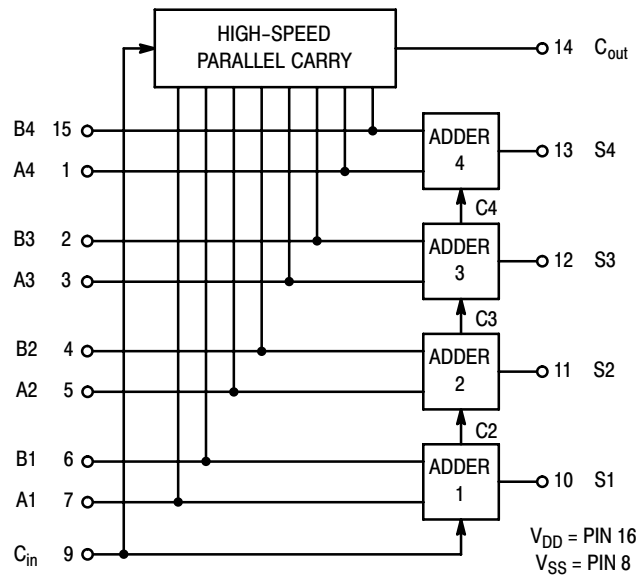
PIN ASSIGNMENT



TRUTH TABLE (One Stage)

| C _{in} | B | A | C _{out} | S |
|-----------------|---|---|------------------|---|
| 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 1 | 0 | 1 |
| 0 | 1 | 0 | 0 | 1 |
| 0 | 1 | 1 | 1 | 0 |
| 1 | 0 | 0 | 0 | 1 |
| 1 | 0 | 1 | 1 | 0 |
| 1 | 1 | 0 | 1 | 0 |
| 1 | 1 | 1 | 1 | 1 |

BLOCK DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|--------------|----------------------|--------------------------|
| MC14015BCP | PDIP-16 | 500 Units / Rail |
| MC14015BCPG | PDIP-16 (Pb-Free) | 500 Units / Rail |
| MC14015BDR2 | SOIC-16 | 2500 Units / Tape & Reel |
| MC14015BDR2G | SOIC-16 (Pb-Free) | 2500 Units / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

| Characteristic | Symbol | V _{DD} Vdc | - 55° C | | 25° C | | | 125° C | | Unit | |
|--|----------------------------|------------------------|---|--------|-------|-----------------|--------|--------|--------|------|------|
| | | | Min | Max | Min | Typ (Note 2) | Max | Min | Max | | |
| Output Voltage V _{in} = V _{DD} or 0 V _{in} = 0 or V _{DD} | "0" Level "1" Level | V _{OL} | 5.0 | — | 0.05 | — | 0 | 0.05 | — | 0.05 | Vdc |
| | | | 10 | — | 0.05 | — | 0 | 0.05 | — | 0.05 | |
| | | | 15 | — | 0.05 | — | 0 | 0.05 | — | 0.05 | |
| | | | 5.0 | 4.95 | — | 4.95 | 5.0 | — | 4.95 | — | Vdc |
| | | | 10 | 9.95 | — | 9.95 | 10 | — | 9.95 | — | |
| | | | 15 | 14.95 | — | 14.95 | 15 | — | 14.95 | — | |
| Input Voltage (V _O = 4.5 or 0.5 Vdc) (V _O = 9.0 or 1.0 Vdc) (V _O = 13.5 or 1.5 Vdc) | "0" Level | V _{IL} | 5.0 | — | 1.5 | — | 2.25 | 1.5 | — | 1.5 | Vdc |
| | | | 10 | — | 3.0 | — | 4.50 | 3.0 | — | 3.0 | |
| | | | 15 | — | 4.0 | — | 6.75 | 4.0 | — | 4.0 | |
| | "1" Level | V _{IH} | 5.0 | 3.5 | — | 3.5 | 2.75 | — | 3.5 | — | Vdc |
| | | | | 10 | 7.0 | — | 7.0 | 5.50 | — | 7.0 | |
| | | | 15 | 11 | — | 11 | 8.25 | — | 11 | — | |
| Output Drive Current (V _{OH} = 2.5 Vdc) (V _{OH} = 4.6 Vdc) (V _{OH} = 9.5 Vdc) (V _{OH} = 13.5 Vdc) (V _{OL} = 0.4 Vdc) (V _{OL} = 0.5 Vdc) (V _{OL} = 1.5 Vdc) | Source | I _{OH} | 5.0 | - 3.0 | — | - 2.4 | - 4.2 | — | - 1.7 | — | mAdc |
| | | | 5.0 | - 0.64 | — | - 0.51 | - 0.88 | — | - 0.36 | — | |
| | | | 10 | - 1.6 | — | - 1.3 | - 2.25 | — | - 0.9 | — | |
| | | | 15 | - 4.2 | — | - 3.4 | - 8.8 | — | - 2.4 | — | |
| | Sink | I _{OL} | 5.0 | 0.64 | — | 0.51 | 0.88 | — | 0.36 | — | mAdc |
| | | | | 10 | 1.6 | — | 1.3 | 2.25 | — | 0.9 | |
| | | | 15 | 4.2 | — | 3.4 | 8.8 | — | 2.4 | — | |
| Input Current | I _{in} | 15 | — | ± 0.1 | — | ± 0.00001 | ± 0.1 | — | ± 1.0 | μAdc | |
| Input Capacitance (V _{in} = 0) | C _{in} | — | — | — | — | 5.0 | 7.5 | — | — | pF | |
| Quiescent Current (Per Package) | I _{DD} | 5.0 | — | 5.0 | — | 0.005 | 5.0 | — | 150 | μAdc | |
| | | 10 | — | 10 | — | 0.010 | 10 | — | 300 | | |
| | | 15 | — | 20 | — | 0.015 | 20 | — | 600 | | |
| Total Supply Current (Notes 3 & 4) (Dynamic plus Quiescent, Per Package) (C _L = 50 pF on all outputs, all buffers switching) | I _T | 5.0 10 15 | I _T = (1.7 μA/kHz) f + I _{DD} I _T = (3.4 μA/kHz) f + I _{DD} I _T = (5.0 μA/kHz) f + I _{DD} | | | | | | | μAdc | |

2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

3. The formulas given are for the typical characteristics only at 25° C.

4. To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$$

where: I_T is in μA (per package), C_L in pF, V = (V_{DD} - V_{SS}) in volts, f in kHz is input frequency, and k = 0.005.

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SWITCHING CHARACTERISTICS (Note 5) ($C_L = 50 \text{ pF}$, $T_A = 25^\circ\text{C}$)

| Characteristic | Symbol | V_{DD} Vdc | Min | Typ (Note 6) | Max | Unit |
|--|-------------------------|--|--|--|--|------|
| Output Rise and Fall Time $t_{TLH}, t_{THL} = (1.5 \text{ ns/pF}) C_L + 25 \text{ ns}$ $t_{TLH}, t_{THL} = (0.75 \text{ ns/pF}) C_L + 12.5 \text{ ns}$ $t_{TLH}, t_{THL} = (0.55 \text{ ns/pF}) C_L + 9.5 \text{ ns}$ | $t_{TLH},$ t_{THL} | 5.0 10 15 | — — — | 100 50 40 | 200 100 80 | ns |
| Propagation Delay Time Sum in to Sum Out $t_{PLH}, t_{PHL} = (1.7 \text{ ns/pF}) C_L + 315 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.66 \text{ ns/pF}) C_L + 127 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.5 \text{ ns/pF}) C_L + 90 \text{ ns}$ Sum In to Carry Out $t_{PLH}, t_{PHL} = (1.7 \text{ ns/pF}) C_L + 220 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.66 \text{ ns/pF}) C_L + 112 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.5 \text{ ns/pF}) C_L + 85 \text{ ns}$ Carry In to Sum Out $t_{PLH}, t_{PHL} = (1.7 \text{ ns/pF}) C_L + 290 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.66 \text{ ns/pF}) C_L + 122 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.5 \text{ ns/pF}) C_L + 90 \text{ ns}$ Carry In to Carry Out $t_{PLH}, t_{PHL} = (1.7 \text{ ns/pF}) C_L + 85 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.66 \text{ ns/pF}) C_L + 42 \text{ ns}$ $t_{PLH}, t_{PHL} = (0.5 \text{ ns/pF}) C_L + 30 \text{ ns}$ | t_{PLH}, t_{PHL} | 5.0 10 15 5.0 10 15 5.0 10 15 5.0 10 15 | — — — — — — — — — — — — | 400 160 115 305 145 110 375 155 115 170 75 55 | 800 320 230 610 290 220 750 310 230 340 150 110 | ns |

5. The formulas given are for the typical characteristics only at 25°C .

6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

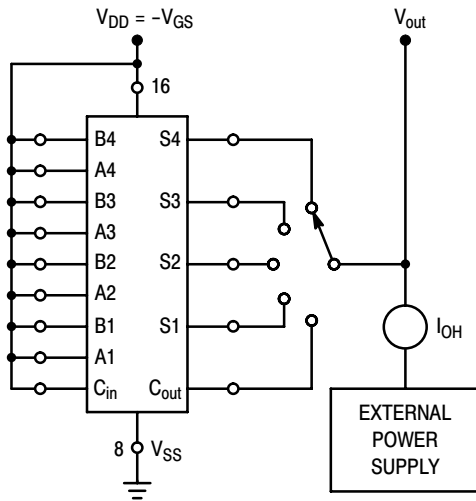


Figure 1. Typical Source Current Characteristics Test Circuit

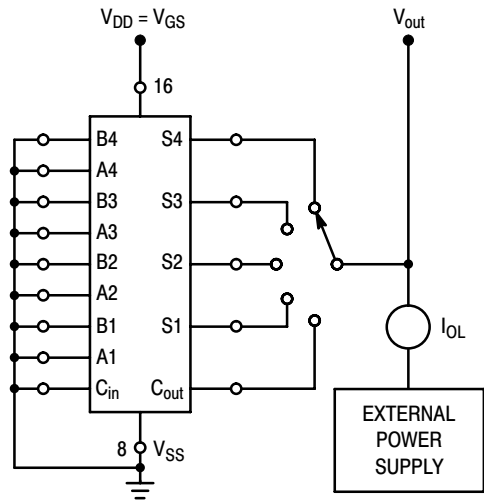


Figure 2. Typical Sink Current Characteristics Test Circuit

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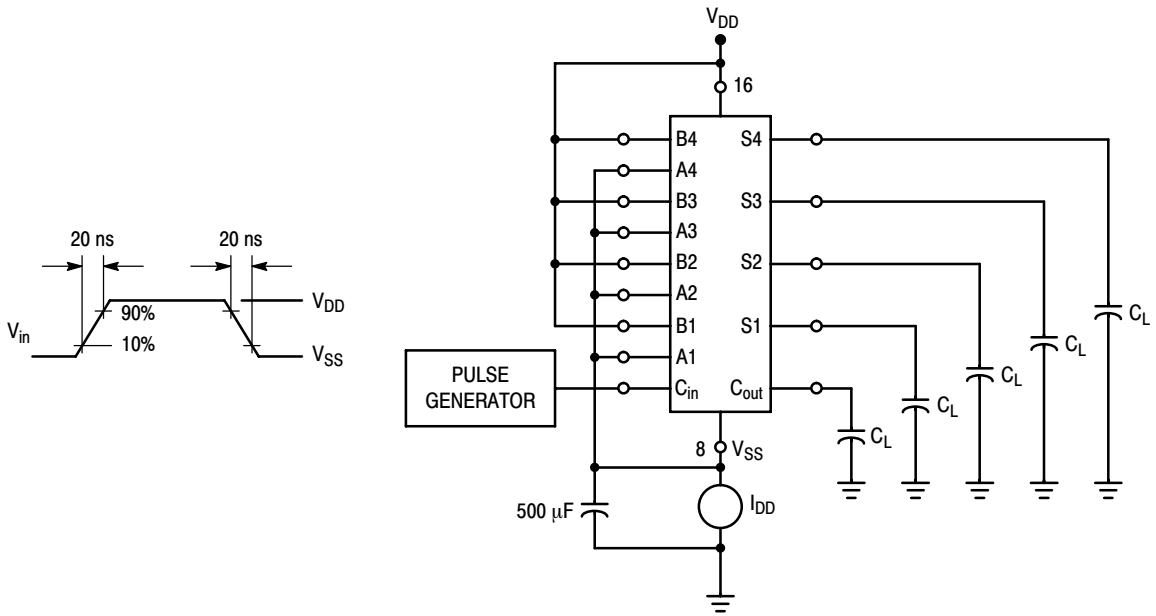


Figure 3. Dynamic Power Dissipation Test Circuit and Waveform

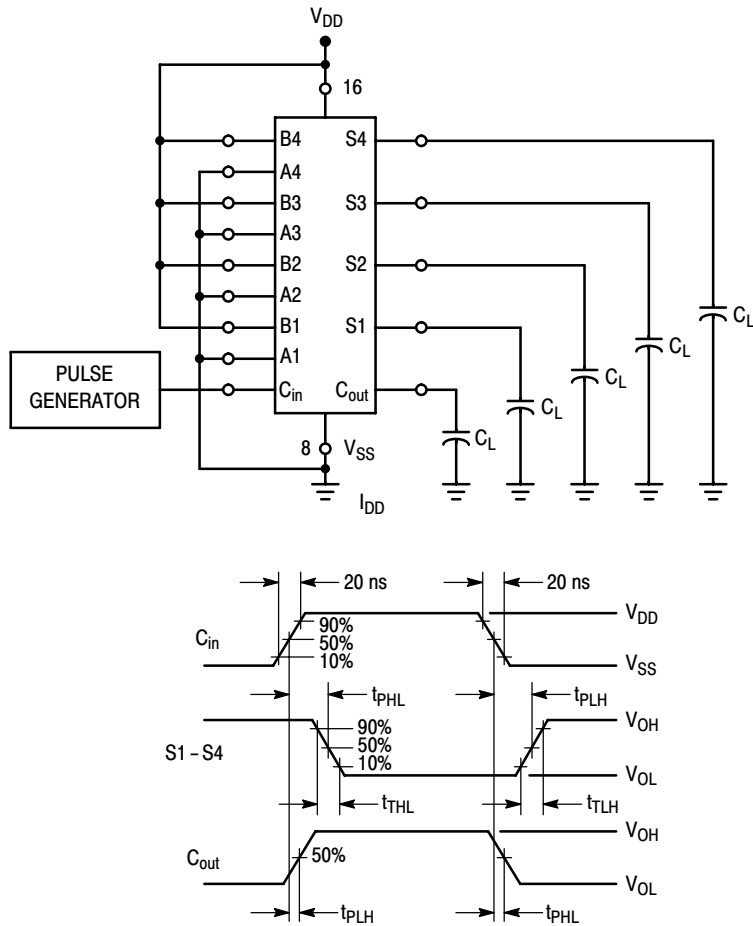


Figure 4. Switching Time Test Circuit and Waveforms

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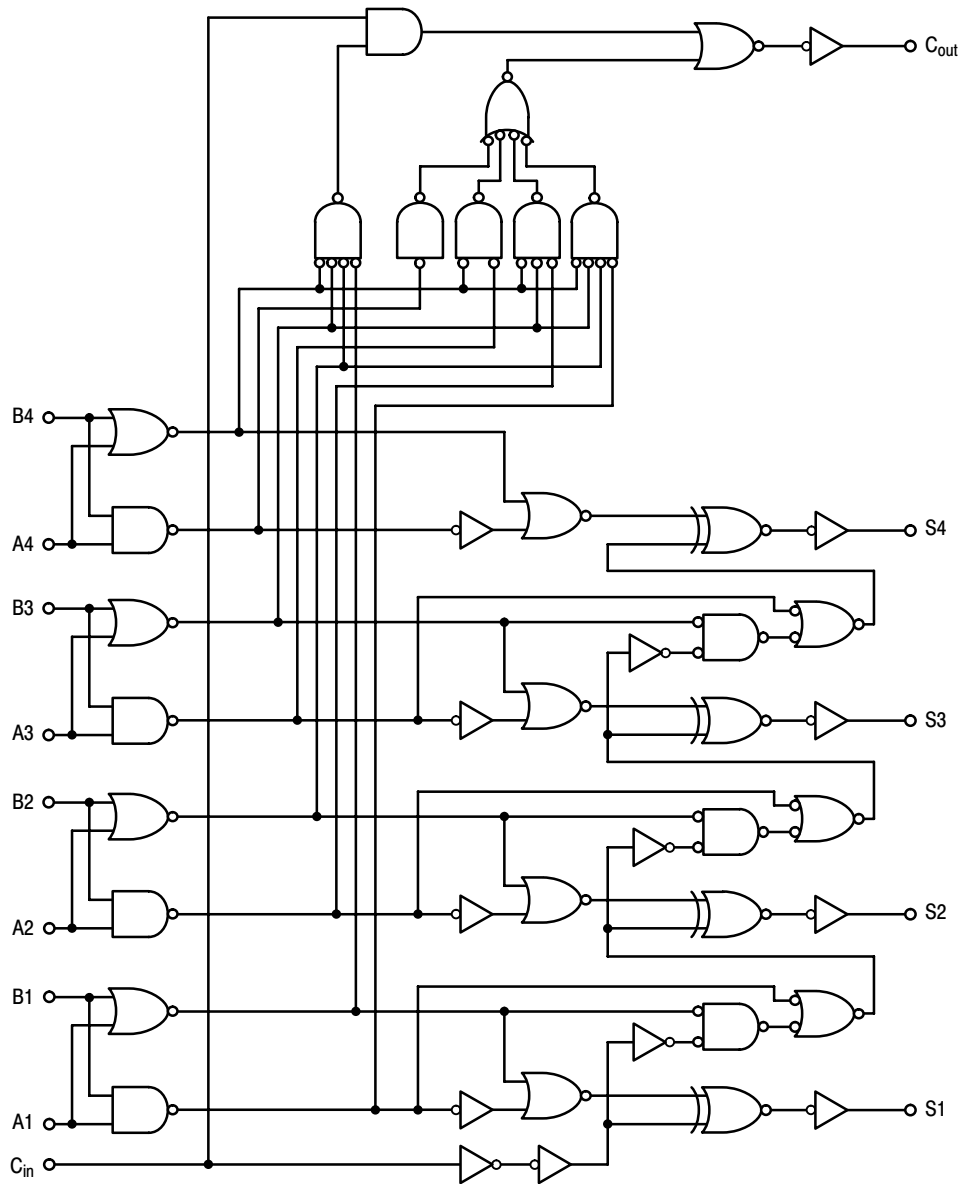
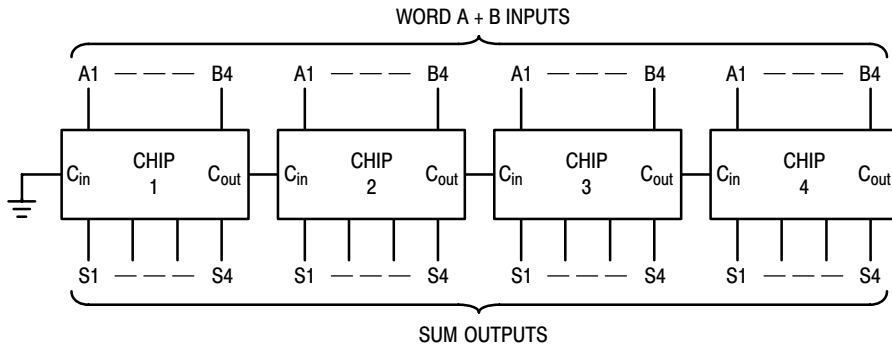


Figure 5. Logic Diagram

TYPICAL APPLICATION



Calculation of 16-bit adder speed:

$$t_p \text{ total} = t_p (\text{Sum to Carry}) + t_p (\text{Carry to Sum}) + 2 t_p (\text{Carry to Carry})$$

The guaranteed 16-bit adder speed at 10 V, 25°C, $C_L = 50 \text{ pF}$ is:

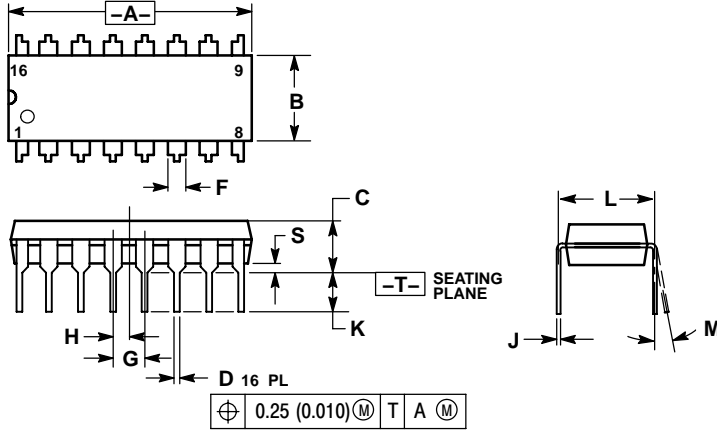
$$t_p \text{ total} = 290 + 310 + 300 = 900 \text{ ns}$$

Figure 6. Using the MC14008B in a 16-Bit Adder Configuration

MC14008B

PACKAGE DIMENSIONS

PDIP-16
P SUFFIX
PLASTIC DIP PACKAGE
CASE 648-08
ISSUE T



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.740 | 0.770 | 18.80 | 19.55 |
| B | 0.250 | 0.270 | 6.35 | 6.85 |
| C | 0.145 | 0.175 | 3.69 | 4.44 |
| D | 0.015 | 0.021 | 0.39 | 0.53 |
| F | 0.040 | 0.70 | 1.02 | 1.77 |
| G | 0.100 BSC | | 2.54 BSC | |
| H | 0.050 BSC | | 1.27 BSC | |
| J | 0.008 | 0.015 | 0.21 | 0.38 |
| K | 0.110 | 0.130 | 2.80 | 3.30 |
| L | 0.295 | 0.305 | 7.50 | 7.74 |
| M | 0° | 10° | 0° | 10° |
| S | 0.020 | 0.040 | 0.51 | 1.01 |

